

HAT2193WP

Silicon N Channel Power MOS FET Power Switching

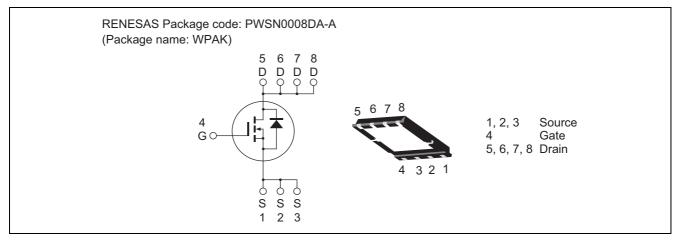
> REJ03G1252-0100 Rev.1.00 Aug.24,2005

> > 2500

Features

- Low on-resistance
- Low drive current
- High density mounting

Outline



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	250	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	7	А
Drain peak current	I _{D (pulse)} Note1	14	А
Body-drain diode reverse drain current	I _{DR}	7	А
Body-drain diode reverse drain peak current	I _{DR (pulse)} Note1	14	А
Avalanche current	I _{AP} ^{Note3}	3.5	А
Avalanche energy	E _{AR} ^{Note3}	0.7	mJ
Channel dissipation	Pch Note2	20	W
Channel to case thermal impedance	θch-c	6.25	°C/W
Channel temperature	Tch	150	۵°
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. $PW \le 10 \ \mu s$, duty cycle $\le 1\%$

2. Value at Tc = 25°C

3. STch = 25° C, Tch $\leq 150^{\circ}$ C



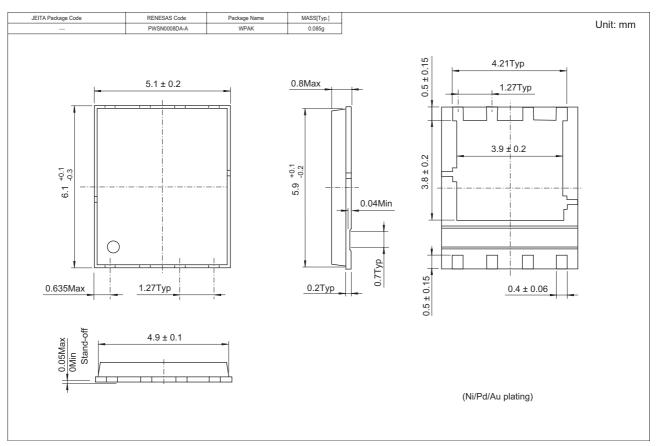
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	V _{(BR)DSS}	250	—		V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Zero gate voltage drain current	I _{DSS}	_	—	1	μΑ	$V_{DS} = 250 \text{ V}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	—	±0.1	μA	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	3.0	—	4.5	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$
Forward transfer admittance	yfs	3	5	_	S	$I_D = 3.5 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$
Static drain to source on state	R _{DS(on)}	_	0.35	0.40	Ω	$I_D = 3.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance						
Input capacitance	Ciss	—	430		pF	V _{DS} = 25 V
Output capacitance	Coss	—	70		pF	V _{GS} = 0 f = 1 MHz
Reverse transfer capacitance	Crss	—	5	—	pF	
Turn-on delay time	t _{d(on)}	_	24	_	ns	$I_{D} = 3.5 \text{ A} \\ V_{GS} = 10 \text{ V} \\ R_{L} = 35.7 \Omega \\ \text{Rg} = 10 \Omega$
Rise time	tr	_	17		ns	
Turn-off delay time	t _{d(off)}	_	46		ns	
Fall time	t _f	_	8		ns	
Total gate charge	Qg	_	10		nC	V _{DD} = 200 V
Gate to source charge	Qgs	_	2.5		nC	V _{GS} = 10 V I _D = 7 A
Gate to drain charge	Qgd		4		nC	
Body-drain diode forward voltage	V _{DF}	_	0.9	1.4	V	$I_F = 7 \text{ A}, V_{GS} = 0^{\text{Note4}}$
Body-drain diode reverse recovery time	trr	_	110	_	ns	$I_{F} = 7 \text{ A}, V_{GS} = 0$
						di _F /dt = 100 A/µs

Notes: 4. Pulse test



Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2193WP-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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